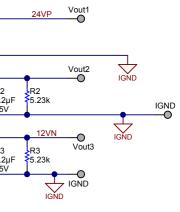
R6	Value	Package	Voltage Rating	Part Number	Manufacture							
	316k	603	N/A	CRCW0603316KFKEA	Vishay-Dale							
R7	150k	603	N/A	CRCW0603150KFKEA	Vishay-Dale							
R9	20.5k	603	N/A	CRCW060320K5FKEA	Vishay-Dale							
R1	15k	603	N/A	CRCW060315K0FKEA	Vishay-Dale							
R2, R3	5.1k	603	N/A	CRCW06035K10JNEA	Vishay-Dale							
C1	2.2uF	805	25V	GRM21BR61E225KA12L	MuRata							
C2	4.7uF	805	16V	GRM21BR71C475KA73L	MuRata							
C3	4.7uF	805	16V	GRM21BR71C475KA73L	MuRata			74		D1		
D1	1.25V/0.2A	SOD 123	100V	BAV19WTPMSDKR-ND	Micro Commercial CO			T1	9			•
D2	0.5V/1A	SOD 123	60V	DFLS160-7	Diodes Inc.				3	RF081M2STR	2.2µF	R1 24.3k
D3	0.5V/1A	SOD 123	60V	DFLS160-7	Diodes Inc.				4	D2	35V	-
								7	11	D2		12
750314462		_	Voltage Rating		Manufacture			ٽز	Įξ	MBR1H10	0SFT3G	
R6	316k		N/A	CRCW0603316KFKEA	Vishay-Dale		_	6	2			
R9	21k		N/A	CRCW060321K0FKEA	Vishay-Dale				3		D3	
R2, R3	10k		N/A	CRCW060310K0FKEA	Vishay-Dale				5		MBR1H100	005720
R1	5.1k		N/A	CRCW06035K10JNEA	Vishay-Dale				1		MBRINIU	JSF 13G
C1	4.7uF		16V	GRM21BR71C475KA73L				75031	4463			
C2	2.2uF		25V	GRM21BR61E225KA12L			sw					
C3	2.2uF		25V	GRM21BR61E225KA12L			5₩					
D1	0.5V/1A	SOD 123		DFLS160-7	Diodes Inc.							
D2 D3	0.6V/0.15A 0.6V/0.15A			BAT46W-7-F BAT46W-7-F	Diodes Inc. Diodes Inc.				•		1	
				100V 1 1 1μF 0 GND	00V 11 33 1µF Fsw=35 R8 8.87k	k k kHz		-C9 ς 1μF	GND	FB FB	R7 154k R9 20.0k	
							C12 000V 1000pF					
						GND	IGND					
						GND	IGND					

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с	ZZ2 Assembly Note These assemblies are ESD sensitive, ESD precaution	ns shall be observed.				c
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	These assemblies must comply with workmanship sta	andards IPC-A-610 Class 2, unless otherwise specified.				
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